

Power SMD LED

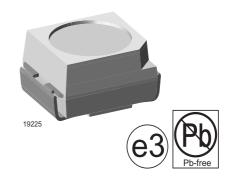
Description

This device have been designed to meet the increasing demand for white SMD LED.

The package of the TLMW330. is the PLCC-2.

It consists of a lead frame which is embedded in a white thermoplast. The reflector inside this package is filled with a mixture of epoxy and TAG phosphor.

The TAG phosphor converts the blue emission partially to yellow, which mixes with the remaining blue to give white.



Features

- · High efficient InGaN technology
- Chromaticity Coordinate categorized according to CIE1931 per packing unit
- Luminous intensity ratio in one packing unit $I_{Vmax}/I_{Vmin} \le 1.75$
- Typical color temperature 5500 K
- ESD class 1
- · EIA and ICE standard package
- Compatible with infrared, vapor phase and wave solder processes according to CECC
- · Available in 8 mm tape reel
- · Lead-free device

Applications

Automotive: Backlighting in dashboards and switches Telecommunication: Indicator and backlighting in telephone and fax

Backlighting for audio and video equipment

Backlighting in office equipment

Indoor and outdoor message boards

Flat backlight for LCDs, switches and symbols

Illumination purposes, alternative to incandescent lamps

General use

Parts Table

Part	Color, Luminous Intensity	Angle of Half Intensity (±φ)	Technology
TLMW3300	White, I _V = 500 mcd (typ.)	60 °	InGaN / TAG on SiC

Absolute Maximum Ratings

 T_{amb} = 25 °C, unless otherwise specified **TLMW330.**

Parameter	Test condition	Symbol	Value	Unit
Reverse voltage		V_R	5	V
DC Forward current	T _{amb} ≤ 50 °C	I _F	30	mA
Surge forward current	t _p ≤ 10 μs	I _{FSM}	0.1	А
Power dissipation	T _{amb} ≤ 50 °C	P_V	127	mW
Junction temperature		T _j	100	°C
Operating temperature range		T _{amb}	- 40 to + 100	°C

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Parameter	Test condition	Symbol	Value	Unit
Storage temperature range		T _{stg}	- 40 to + 100	°C
Soldering temperature	t ≤ 5 s	T _{sd}	260	°C
Thermal resistance junction/ ambient	mounted on PC board (pad size > 16 mm ²)	R _{thJA}	400	K/W

Optical and Electrical Characteristics

 $T_{amb} = 25$ °C, unless otherwise specified

White

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Parameter	Test condition	Part	Symbol	Min	Тур.	Max	Unit
Luminous intensity	I _F = 20 mA	TLMW3300	I _V	250	500		mcd
Chromaticity coordinate x acc. to CIE 1931	I _F = 20 mA	TLMW3300	х	0.315		0.365	
Chromaticity coordinate y acc. to CIE 1931	I _F = 20 mA	TLMW3300	У	0.290		0.440	
Angle of half intensity	I _F = 20 mA		φ		± 60		deg
Forward voltage	I _F = 20 mA		V _F		3.7	4.2	V
Reverse voltage	I _R = 10 μA		V _R	5			V
Temperature coefficient of V _F	I _F = 20 mA		TC _{VF}		- 4		mV/K
Temperature coefficient of I _V	I _F = 20 mA		TC _{IV}		- 0.5		% / K

Chromaticity Coordinate Classification

Group	X		Y	
	min	max	min	max
3a	0.2900	0.3025	Y = 1.4 x - 0.121	Y = 1.4 x - 0.071
3b	0.3025	0.3150	Y = 1.4 x - 0.121	Y = 1.4 x - 0.071
3c	0.2900	0.3025	Y = 1.4 x - 0.171	Y = 1.4 x - 0.121
3d	0.3025	0.3150	Y = 1.4 x - 0.171	Y = 1.4 x - 0.121
4a	0.3150	0.3275	Y = 1.4 x - 0.121	Y = 1.4 x - 0.071
4b	0.3275	0.3400	Y = 1.4 x - 0.121	Y = 1.4 x - 0.071
4c	0.3150	0.3275	Y = 1.4 x - 0.171	Y = 1.4 x - 0.121
4d	0.3275	0.3400	Y = 1.4 x - 0.171	Y = 1.4 x - 0.121
5a	0.3400	0.3525	Y = 1.4 x - 0.121	Y = 1.4 x - 0.071
5b	0.3525	0.3650	Y = 1.4 x - 0.121	Y = 1.4 x - 0.071
5c	0.3400	0.3525	Y = 1.4 x - 0.171	Y = 1.4 x - 0.121
5d	0.3525	0.3650	Y = 1.4 x - 0.171	Y = 1.4 x - 0.121

Luminous Intensity Classification

Group	Luminous Intensity (mcd)		
	min	max	
Ya	250	400	
Yb	320	500	
Za	400	630	
Zb	500	800	

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Typical Characteristics (Tamb = 25 °C unless otherwise specified)

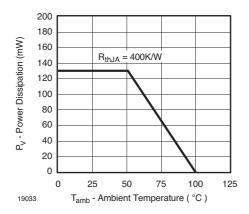


Figure 1. Power Dissipation vs. Ambient Temperature

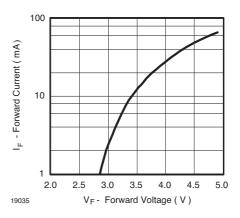


Figure 4. Forward Current vs. Forward Voltage

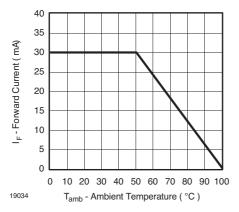


Figure 2. Forward Current vs. Ambient Temperature for InGaN

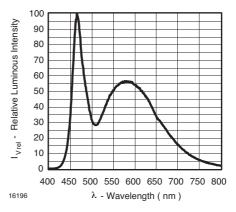


Figure 5. Relative Intensity vs. Wavelength

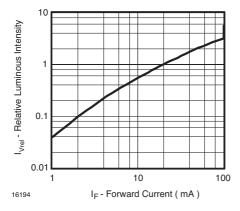


Figure 3. Relative Luminous Intensity vs. Forward Current

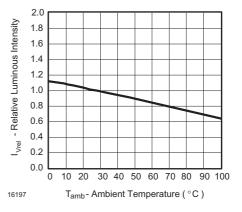


Figure 6. Rel. Luminous Intensity vs. Ambient Temperature

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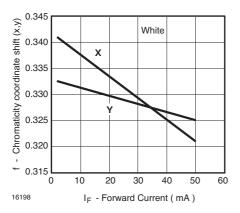


Figure 7. Chromaticity Coordinate Shift vs. Forward Current

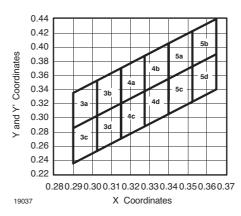


Figure 10. Coordinates of Colorgroups

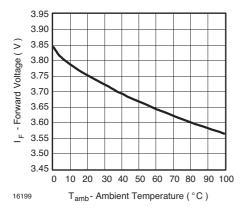


Figure 8. Forward Voltage vs. Ambient Temperature

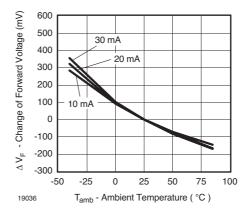


Figure 11. Change of Forward Voltage vs. Ambient Temperature

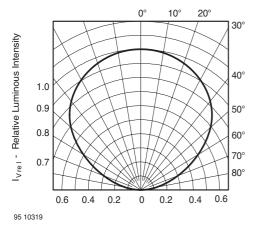
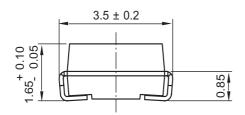


Figure 9. Rel. Luminous Intensity vs. Angular Displacement

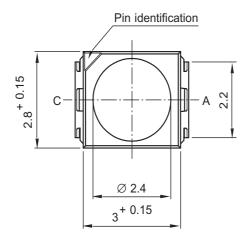


Package Dimensions in mm





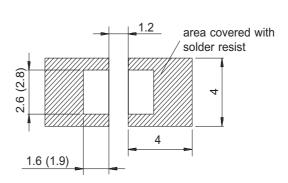
Mounting Pad Layout



Drawing-No.: 6.541-5025.01-4

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Dimensions: IR and Vaporphase (Wave Soldering)

TLMW330.

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Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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